

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

## **BIB DATA SHEET**

## **CONFIRMATION NO. 1659**

## APPLICANTS   Tadashi Maeda, Kadoma, JAPAN;   Tadashi Maeda, Ma		IAL NUMBER FILING O		Έ ΄		GROUP ART UNIT			ATTORNEY DOCKET NO.			
APPLICANTS Tadashi Maeda, Kadoma, JAPAN; This application is a 371 of PCT/JP05/01087 01/27/2005  *** FOREIGN APPLICATIONS *** JAPAN 2004-021090 01/29/2004 JAPAN 2004-021090 01/29/2004 JAPAN 2004-021090 01/29/2004 JAPAN 2004-02740 11/11/2004  *** IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** O6/26/2008  Foreign Priority claimed						029	1793			2006_1151A		
Tadashi Maeda, Kadoma, JAPAN; Tadahiko Sakai, Kadoma, JAPAN; Tadahiko Sakai, Kadoma, JAPAN; Tadahiko Sakai, Kadoma, JAPAN; Tocontinuing DATA**** This application is a 371 of PCT/JP05/01087 01/27/2005  ** FOREIGN APPLICATIONS**** JAPAN 2004-021090 01/29/2004 JAPAN 2004-327440 11/11/2004  ** IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 06/26/2008  Foreign Priority claimed	RUL			<u>E</u>								
This application is a 371 of PCT/JP05/01087 01/27/2005  *** FOREIGN APPLICATIONS  JAPAN 2004-021090 01/29/2004  JAPAN 2004-327440 11/11/2004  *** IF REQUIRED, FOREIGN FILING LICENSE GRANTED **	Tadashi Maeda, Kadoma, JAPAN;											
JAPAN 2004-021090 01/29/2004 JAPAN 2004-327440 11/11/2004  ***IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 06/26/2008  Foreign Priority claimed												
Foreign Priority claimed	JAPAN 2004-021090 01/29/2004											
35 USC 119(a-d) conditions met Yes \ No Verified and Acknowledged												
Verified and Acknowledged   MEGHA S MEHTAV Examiner's Signature   Tinitials   JAPAN   6   23   3   3	35 USC 119(a-d) conditions met Yes No Verified and /MEGHA S MEHTA/			☐ Met after					_			
WENDEROTH, LIND & PONACK, L.L.P. 2033 K STREET N. W. SUITE 800 WASHINGTON, DC 20006-1021 UNITED STATES  TITLE  Flux for Soldering and Soldering Process  FILING FEE RECEIVED 1050  All Fees  All Fees  1.16 Fees (Filing)  1.17 Fees (Processing Ext. of time)  1.18 Fees (Issue)						JAPAN		6 23		}	3	
2033 K STREET N. W. SUITE 800 WASHINGTON, DC 20006-1021 UNITED STATES  TITLE  Flux for Soldering and Soldering Process  FILING FEE RECEIVED 1050  FEES: Authority has been given in Paper No to charge/credit DEPOSIT ACCOUNT No for following:    All Fees     1.16 Fees (Filing)     1.17 Fees (Processing Ext. of time)     1.18 Fees (Issue)	ADDRESS											
FILING FEE RECEIVED 1050  FILING FOR Soldering and Soldering Process  FILING FEE RECEIVED 1050  FEES: Authority has been given in Paper No to charge/credit DEPOSIT ACCOUNT No for following:    All Fees   1.16 Fees (Filing)   1.17 Fees (Processing Ext. of time)   1.18 Fees (Issue)   1.18 Fees (Issue)	2033 K STREET N. W. SUITE 800 WASHINGTON, DC 20006-1021											
FILING FEE RECEIVED 1050  FILING FEE RECEIVED 1050  FEES: Authority has been given in Paper 1.16 Fees (Filing)  In 1.17 Fees (Processing Ext. of time)  In 1.18 Fees (Issue)	TITLE											
FILING FEE RECEIVED 1050  FEES: Authority has been given in Paper No to charge/credit DEPOSIT ACCOUNT No for following:  1.16 Fees (Filing)  1.17 Fees (Processing Ext. of time)  1.18 Fees (Issue)	Flux for Soldering and Soldering Process											
FILING FEE RECEIVED 1050  FEES: Authority has been given in Paper No to charge/credit DEPOSIT ACCOUNT No for following:  1.17 Fees (Processing Ext. of time)  1.18 Fees (Issue)		EEEO. Authority had been situad in Daney					☐ All Fees					
RECEIVED  1050  No to charge/credit DEPOSIT ACCOUNT  No for following:  1.17 Fees (Processing Ext. of time)  1.18 Fees (Issue)							☐ 1.16 Fees (Filing)					
1050 No for following:		Noto charge/credit DEPOSIT ACCOUNT						☐ 1.17 Fees (Processing Ext. of time)				
□ Other								☐ 1.18 Fees (Issue)				
							Other					
☐ Credit							☐ Credit					